10-bit transparent latch with 5 V tolerant inputs/outputs; 3-state

Rev. 4 — 2 April 2013

Product data sheet

1. General description

The 74LVC841A is a 10-bit transparent latch featuring separate D-type inputs for each latch and 3-state outputs for bus applications. A latch enable (pin \overline{LE}) input and an output enable (pin \overline{OE}) input are common to all internal latches. The device consists of ten transparent latches with 3-state true outputs. When pin LE is HIGH, data at the Dn inputs enters the latches. In this condition, the latches are transparent, that is, a latch output changes each time its corresponding D-input changes. When pin \overline{LE} is LOW, the latches store the information that was present at the D-inputs a set-up time preceding the HIGH to LOW transition of pin \overline{LE} .

When pin \overline{OE} is LOW, the contents of the ten latches are available at the outputs. When pin \overline{OE} is HIGH, the outputs go to the high-impedance OFF-state. Operation of the pin \overline{OE} input does not affect the state of the latches.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3 V and 5 V applications.

2. Features and benefits

- 5 V tolerant inputs/outputs; for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Flow-through pinout architecture
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A (2.3 V to 2.7 V)
 - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C.

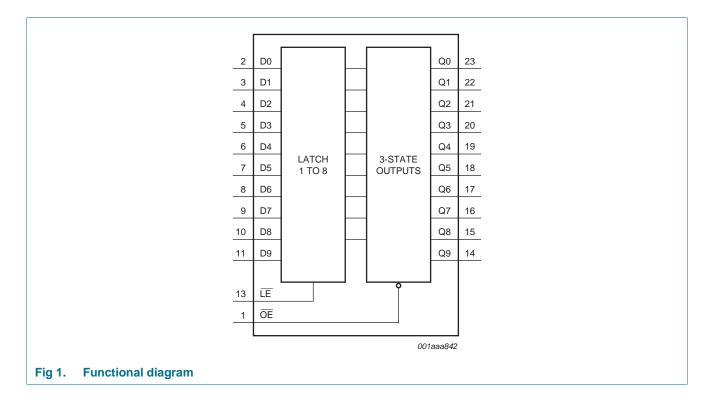


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Ordering information 3.

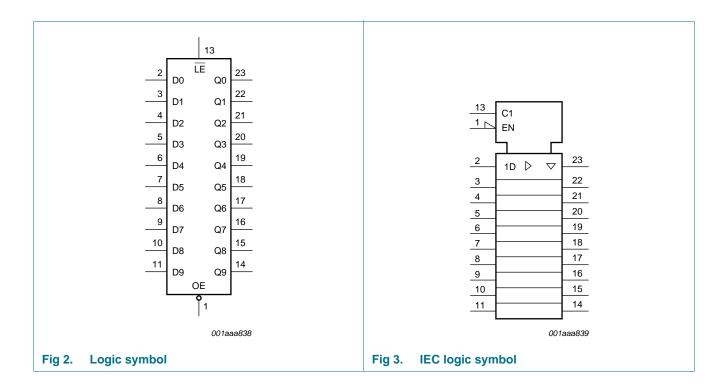
Type number	Package	Package						
	Temperature range	Name	Description	Version				
74LVC841AD	–40 °C to +125 °C	SO24	plastic small outline package; 24 leads; body width 7.5 mm	SOT137-				
74LVC841ADB	–40 °C to +125 °C	SSOP24	plastic shrink small outline package; 24 leads; body width 5.3 mm	SOT340-				
74LVC841APW	–40 °C to +125 °C	TSSOP24	plastic thin shrink small outline package; 24 leads; body width 4.4 mm	SOT355-				
74LVC841ABQ	–40 °C to +125 °C	DHVQFN24	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body 3.5 x 5.5 x 0.85 mm	SOT815-				

4. Functional diagram



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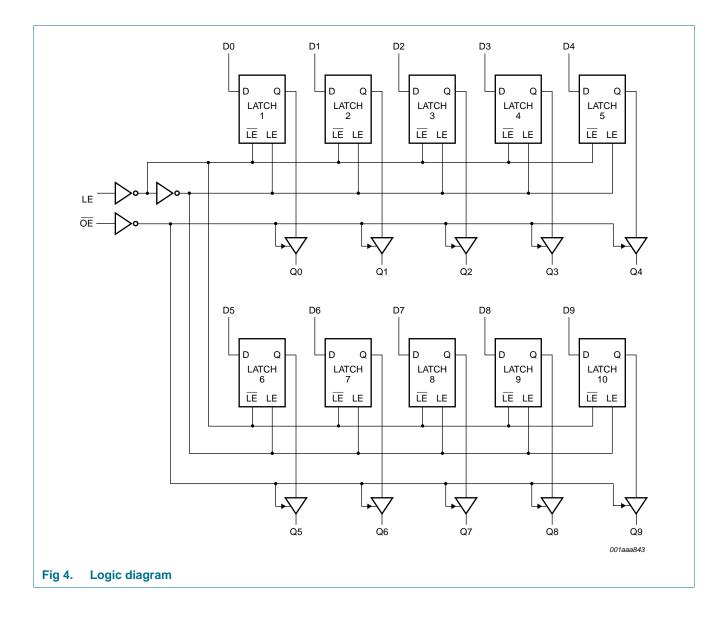
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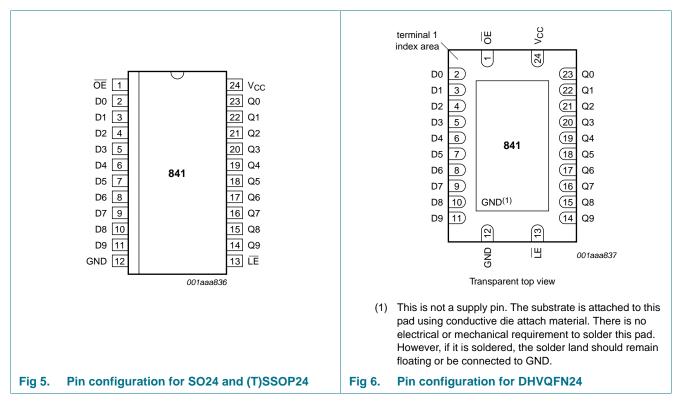
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5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2.	Pin description	
Pin	Symbol	Description
1	OE	output enable input (active LOW)
12	GND	ground (0 V)
13	LE	latch enable input (active LOW)
D[0:9]	2, 3, 4, 5, 6, 7, 8, 9, 10, 11	data input
Q[0:9]	23, 22, 21, 20, 19, 18, 17, 16, 15, 14	3-state latch output
24	V _{CC}	supply voltage

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6. Functional description

Table 3.Function table^[1]

Operating mode	Input		Internal latches	s Output	
	OE	LE	Dn		Qn
Enable and read register (transparent mode)	L	Н	L	L	L
	L	Н	Н	Н	Н
Latch and read register	L	L	Ι	L	L
	L	L	h	Н	Н
Latch register and disable	Н	L	Ι	L	Z
outputs	Н	L	h	Н	Z
Hold	L	L	Х	NC	NC

[1] H = HIGH voltage level

h = HIGH voltage level one set-up time prior to the HIGH to LOW LE transition

L = LOW voltage level

I = LOW voltage level one set-up time prior to the HIGH to LOW LE transition

Z = high-impedance OFF-state

X = don't care

NC = no change

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage		[1] -0.5	+6.5	V
I _{OK}	output clamping current	$V_{O} > V_{CC}$ or $V_{O} < 0 V$	-	±50	mA
Vo	output voltage	HIGH or LOW state	[2] -0.5	V _{CC} + 0.5	V
		3-state	[2] -0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to V_{CC}	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$	<u>[3]</u> _	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

For SO24 packages: above 70 °C derate linearly with 8 mW/K.
 For (T)SSOP24 packages: above 60 °C derate linearly with 5.5 mW/K.
 For DHVQFN24 packages: above 60 °C derate linearly with 4.5 mW/K.

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8. Recommended operating conditions

Table 5.	Recommended operating condition	ons			
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		1.65	3.6	V
		functional	1.2	-	V
VI	input voltage		0	5.5	V
Vo	output voltage	HIGH or LOW state	0	V _{CC}	V
		3-state	0	5.5	V
T _{amb}	ambient temperature	in free air	-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 1.65 V to 2.7 V	0	20	ns/V
		$V_{CC} = 2.7 V \text{ to } 3.6 V$	0	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	S5 ℃	–40 °C to	o +125 ℃	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
VIH	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		$V_{CC} = 2.7 V \text{ to } 3.6 V$	2.0	-	-	2.0	-	V
V _{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V_{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24$ mA; $V_{CC} = 3.0$ V	2.2	-	-	2.0	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = 100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	-	-	0.2	-	0.3	V
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		I_0 = 12 mA; V_{CC} = 2.7 V	-	-	0.4	-	0.6	V
		I _O = 24 mA; V _{CC} = 3.0 V	-	-	0.55	-	0.8	V
I	input leakage current	V_{CC} = 3.6 V; V_{I} = 5.5 V or GND	-	±0.1	±5	-	±20	μA
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Symbol	Parameter	Conditions	-40	°C to +85	°C	–40 °C to	o +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
I _{OZ}	OFF-state output current	$\label{eq:VI} \begin{array}{l} V_{IH} \text{ or } V_{IL}; V_{CC} = 3.6 \ \text{V}; \\ V_{O} = 5.5 \ \text{V} \text{ or } \text{GND}; \end{array}$	-	0.1	±5	-	±20	μA
I _{OFF}	power-off leakage current	V_{CC} = 0 V; V _I or V _O = 5.5 V	-	0.1	±10	-	±20	μA
I _{CC}	supply current	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 3.6 \ V; \ V_{I} = V_{CC} \ \text{or GND}; \\ I_{O} = 0 \ A \end{array}$	-	0.1	10	-	40	μΑ
Δl _{CC}	additional supply current	per input pin; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_I = V_{CC} - 0.6 V; I_O = 0 A$	-	5	500	-	5000	μΑ
CI	input capacitance	$V_{CC} = 0 V$ to 3.6 V; $V_I = GND$ to V_{CC}	-	5.0	-	-	-	pF

Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 11.

Symbol	Parameter	Conditions		T _{amb} =	–40 °C to	+85 °C	-40 °C to	o +125 ℃	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _{pd}	propagation	Dn to Qn; see Figure 7	[2]						
	delay	V _{CC} = 1.2 V		-	15	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.8	6.9	15.2	1.8	17.6	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	3.6	8.0	1.5	9.3	ns
	$V_{CC} = 2.7 V$		1.5	3.6	7.5	1.5	9.5	ns	
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	3.1	6.7	1.5	8.5	ns
		LE to Qn; see Figure 8	[2]						
		V _{CC} = 1.2 V		-	17	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		2.3	7.9	17.7	2.3	20.4	ns
		V_{CC} = 2.3 V to 2.7 V		1.7	4.1	9.1	1.7	10.5	ns
		$V_{CC} = 2.7 V$		1.5	3.8	8.6	1.5	11.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	3.5	7.6	1.5	9.5	ns
t _{en}	enable time	OE to Qn; see Figure 10	[2]						
		V _{CC} = 1.2 V		-	19	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.8	7.6	16.5	1.8	19.0	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	4.3	9.1	1.5	10.5	ns
		$V_{CC} = 2.7 V$		1.5	4.3	8.5	1.5	11.0	ns
		V_{CC} = 3.0 V to 3.6 V		1.5	3.4	7.2	1.5	9.0	ns

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Symbol	Parameter	Conditions		T _{amb} =	–40 °C to	+85 °C	–40 °C to	• +125 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _{dis}	disable time	OE to Qn; see Figure 10	[2]						
		V _{CC} = 1.2 V		-	8.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V		2.6	4.4	9.8	2.6	11.3	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	2.5	5.5	1.0	6.4	ns
		$V_{CC} = 2.7 V$		1.5	3.3	6.6	1.5	8.5	ns
		V_{CC} = 3.0 V to 3.6 V		1.5	3.1	5.9	1.5	7.5	ns
t _W	pulse width	LE HIGH; see Figure 8							
		V_{CC} = 1.65 V to 1.95 V		4.0	-	-	4.0	-	ns
	V_{CC} = 2.3 V to 2.7 V		3.0	-	-	3.0	-	ns	
		$V_{CC} = 2.7 V$		2.0	-	-	2.0	-	ns
		V_{CC} = 3.0 V to 3.6 V		2.0	0.7	-	2.0	-	ns
t _{su} set-up	set-up time	Dn to LE; see Figure 9							
		V _{CC} = 1.65 V		3.5	-	-	3.5	-	ns
		V_{CC} = 2.3 V to 2.7 V		2.5	-	-	2.5	-	ns
		$V_{CC} = 2.7 V$		2.0	-	-	2.0	-	ns
		V_{CC} = 3.0 V to 3.6 V		2.0	1.0	-	2.0	-	ns
t _h	hold time	Dn to LE; see Figure 9							
		V _{CC} = 1.65 V		3.0	-	-	3.0	-	ns
		V_{CC} = 2.3 V to 2.7 V		2.0	-	-	2.0	-	ns
		$V_{CC} = 2.7 V$		1.0	-	-	1.0	-	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	0.0	-	1.0	-	ns
t _{sk(o)}	output skew time	V_{CC} = 3.0 V to 3.6 V	<u>[3]</u>	-	-	1.0	-	1.5	ns
C _{PD}	power	per input; $V_I = GND$ to V_{CC}	<u>[4]</u>						
	dissipation	V_{CC} = 1.65 V to 1.95 V		-	5.8	-	-	-	pF
	capacitance	V_{CC} = 2.3 V to 2.7 V		-	9.3	-	-	-	pF
		V_{CC} = 3.0 V to 3.6 V		-	12.4	-	-	-	pF

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 11.

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

 t_{dis} is the same as t_{PLZ} and t_{PHZ} .

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz; f_o = output frequency in MHz

C_L = output load capacitance in pF

V_{CC} = supply voltage in Volts

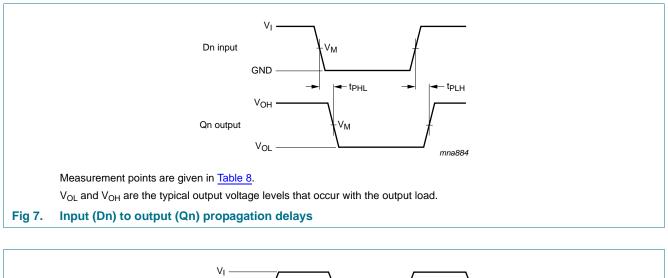
N = number of inputs switching

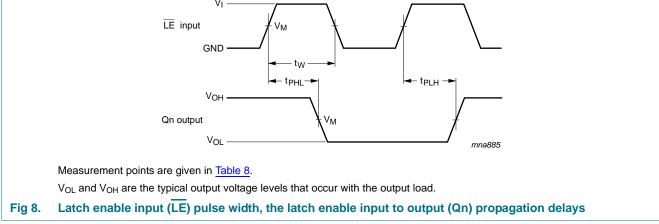
 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of the outputs

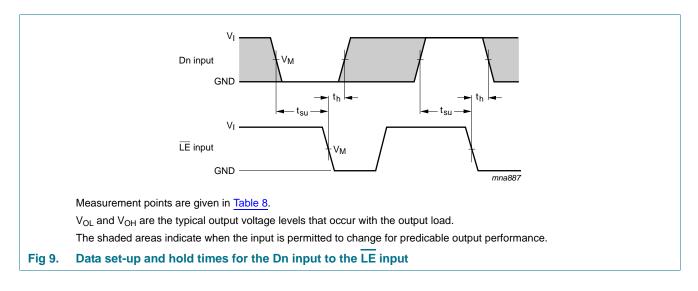
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11. Waveforms







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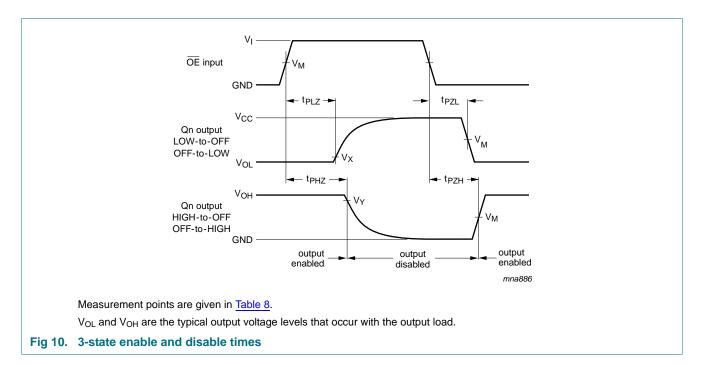
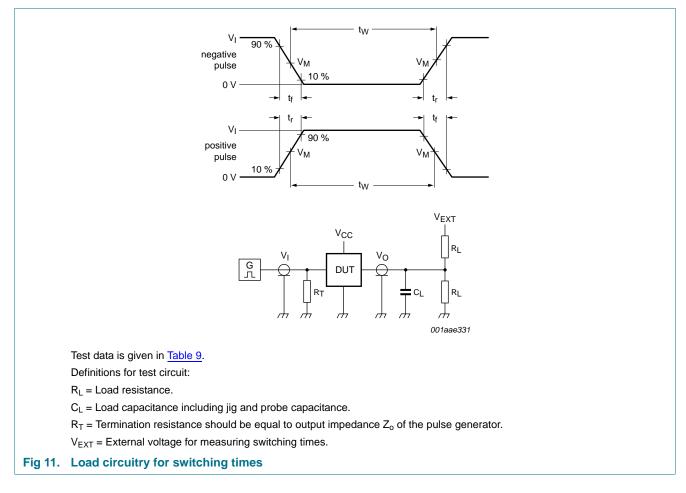


Table 8. Measurement points

Supply voltage	Input		Output	Output				
V _{cc}	VI	V _M	V _M	V _X	V _Y			
1.2 V	V _{CC}	$0.5\times V_{CC}$	$0.5 \times V_{CC}$	V _{OL} + 0.15 V	$V_{OH} - 0.15 \ V$			
1.65 V to 1.95 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V			
2.3 V to 2.7 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V			
2.7 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} – 0.3 V			
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	$V_{OH} - 0.3 V$			

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	Tabl	e 9.	Test	data
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Supply voltage	Input		Load	Load		V _{EXT}		
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}	
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND	
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2 \times V_{CC}$	GND	
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	

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12. Package outline

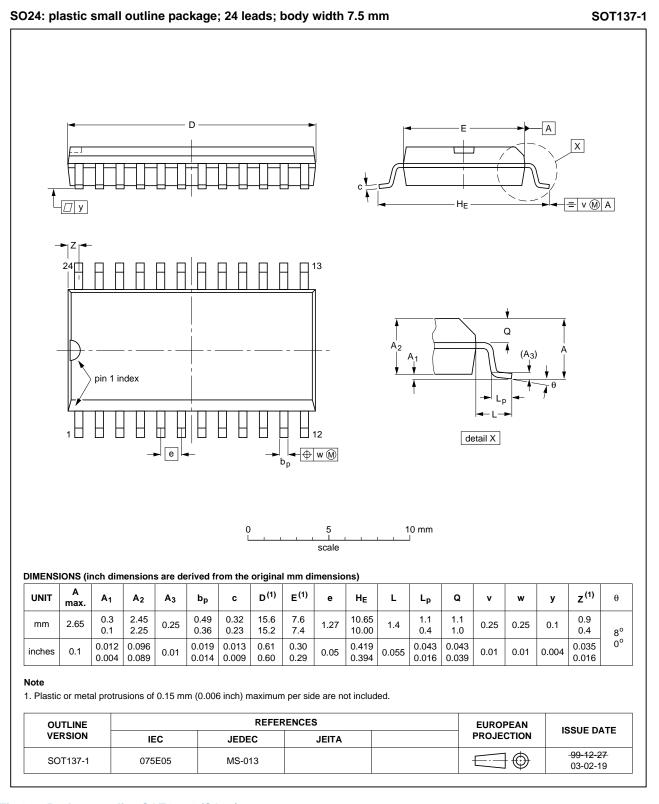


Fig 12. Package outline SOT137-1 (SO24)

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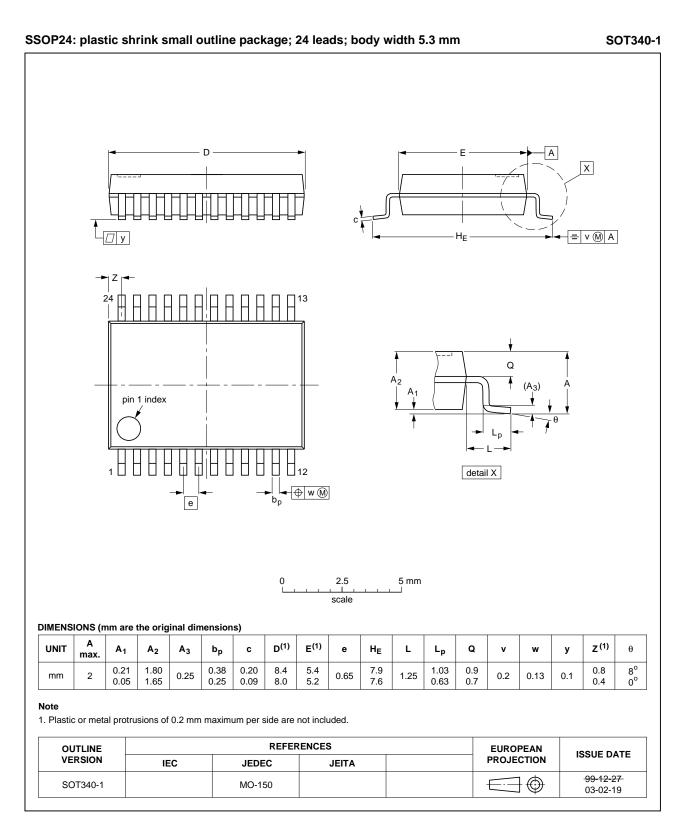


Fig 13. Package outline SOT340-1 (SSOP24)

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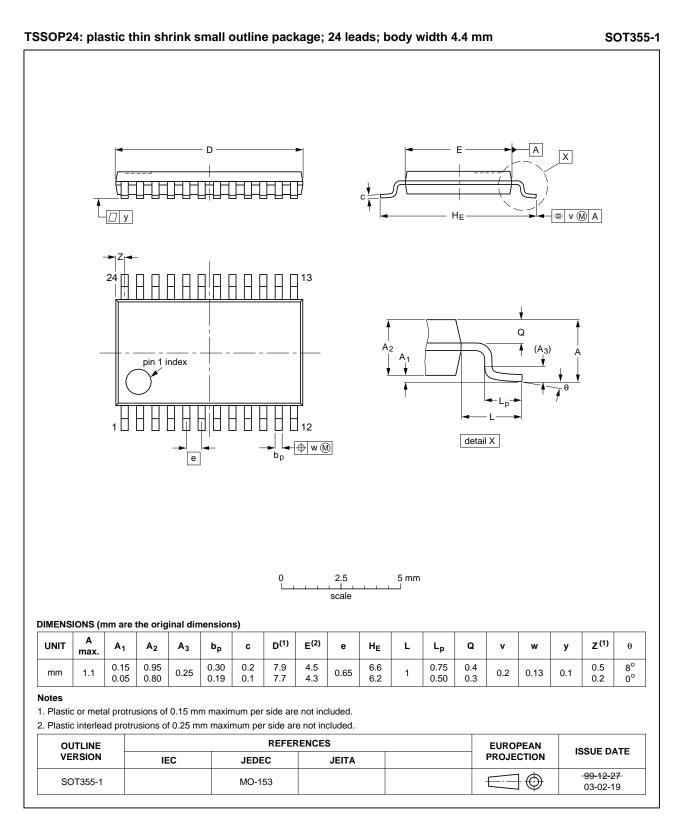


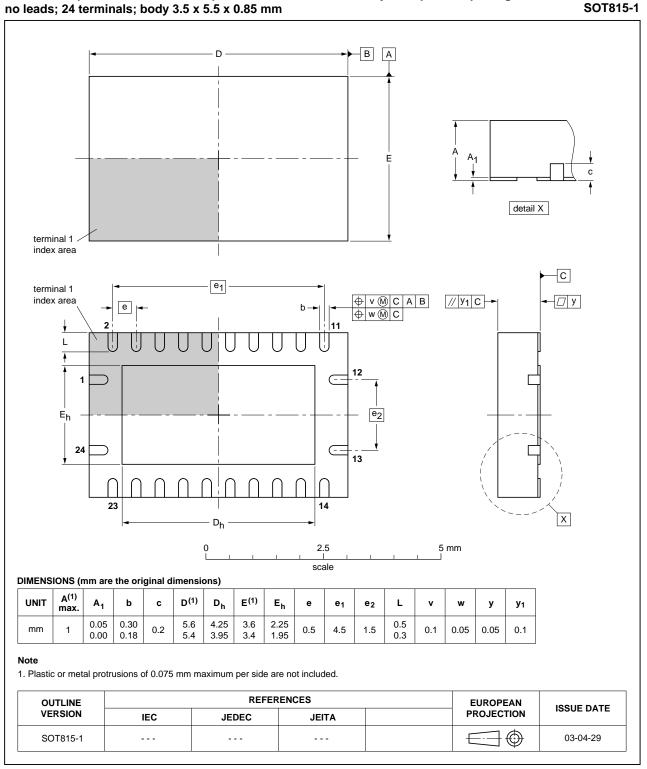
Fig 14. Package outline SOT355-1 (TSSOP24)

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DHVQFN24: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body 3.5 x 5.5 x 0.85 mm

Fig 15. Package outline SOT815-1 (DHVQFN24)

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13. Abbreviations

Table 10. Abbreviations				
Acronym	Description			
CDM	Charged Device Model			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
MM	Machine Model			
TTL	Transistor-Transistor Logic			

14. Revision history

Table 11. Revision	history				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVC841A v.4	20130402	Product data sheet	-	74LVC841A v.3	
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 				
	 Legal texts have been adapted to the new company name where appropriate. 				
	• Table 4, Table	<u>5, Table 6, Table 7, Table 8</u> a	and <u>Table 9</u> : values ad	ded for lower voltage ranges.	
74LVC841A v.3	20040524	Product specification	-	74LVC841A v.2	
74LVC841A v.2	19980617	Product specification	-	74LVC841A v.1	
74LVC841A v.1	19980617	Product specification	-	-	

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Product data sheet

10-bit transparent latch with 5 V tolerant inputs/outputs; 3-state

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10-bit transparent latch with 5 V tolerant inputs/outputs; 3-state

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